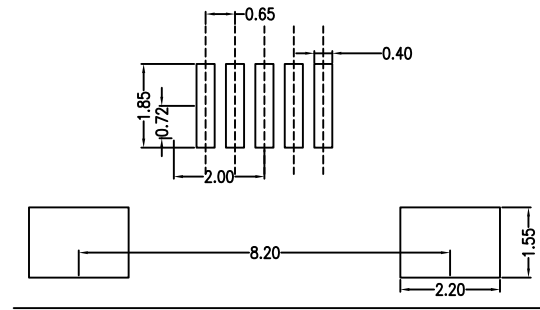
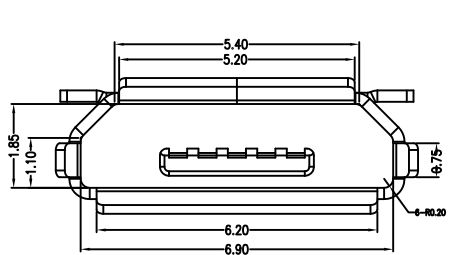
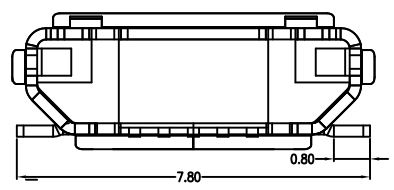
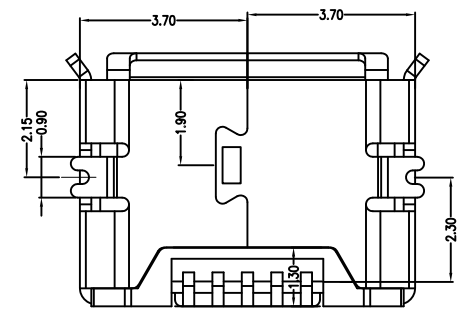
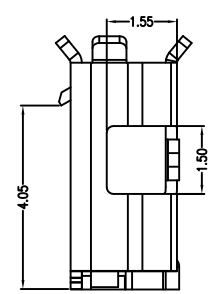
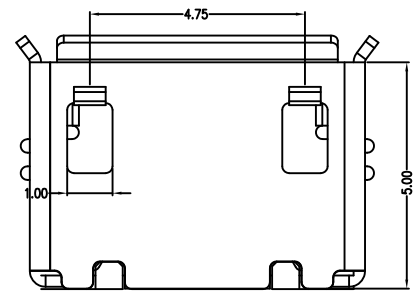




PCB LAYOUT



Material:

- 1.1 Housing: High Temperature thermoplastic with g.f, UL94v-0
- 1.2 Contact: copper alloy, $t=0.20\text{mm}$
- 1.3 Shell: copper alloy, $t=0.25\text{mm}$
2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 50 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total mating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 10000 insertion/extraction cycles
 - 2.7 Temperature range: -30°C~80°C



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RoHS Compliant

DRAWING BY CY		X. ± 0.45
CHECKED BY GENIUS		.X ± 0.30
UNIT / mm		.XX ± 0.15
SCALE 1 : 1		.XXX $\pm$
DATE		ANG $\pm$

TOLERANCES ARE

SIZE A4 PROJECTION

照片框

ORDER INFORMATION

MISB-SWE-5B-LF
 SERIES LEADFREE
 5 PIN B TYPE
 EAR
 90°SMT
 FEMALE

DESCRIPTION: